

INFORMATION DISCLOSURE STATEMENT BY APPLICANT FEB 25 2003 Form PTO-1449 (Modified) (Use several sheets if necessary)				COMPLETE IF KNOWN	
Sheet	1	of	4	Application Number	09/651,779
				Confirmation Number	2448
				Filing Date	August 30, 2000
				First Named Inventor	Scott E. Moore
				Group Art Unit	3723
				Examiner Name	Dung V. Nguyen
				Attorney Docket No.	108298515US

## U.S. PATENT DOCUMENTS

Examiner Initials*	Cite No.	U.S. Patent or Application NUMBER		Name of Patentee or Inventor of Cited Document	Date of Publication or Filing Date of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
		Kind Code (if known)				
SVN	AA✓	U.S. Application No. 09/651,808 (Atty. Docket No. 4373US)		Chopra et al.	Filed 08/30/2000	
	AB✓	U.S. Application No. 09/653,392 (Atty. Docket No. MTI-31044)		Chopra et al.	Filed 08/31/2000	
	AC✓	U.S. Application No. 10/090,869 (Atty. Docket No. 10829.8544US)		Moore et al.	Filed 03/04/2002	
	AD✓	U.S. Application No. 10/230,463 (Atty. Docket No. 10829.8672US)		Lee et al.	Filed 08/29/2002	
	AE✓	U.S. Application No. 10/230,602 (Atty. Docket No. 10829.8674US)		Chopra	Filed 08/29/2002	
	AF✓	U.S. Application No. 10/230,628 (Atty. Docket No. 10829.8673US)		Lee et al.	Filed 08/29/2002	
	AG✓	U.S. Application No. 10/230,970 (Atty. Docket No. 10829.8515US6)		Lee et al.	Filed 08/29/2002	TECHNOLOGY CENTER R3700 MAR 04 2003
	AH✓	U.S. Application No. 10/230,972 (Atty. Docket No. 10829.8515US7)		Lee et al.	Filed 08/29/2002	
	AI✓	U.S. Application No. 10/230,973 (Atty. Docket No. 10829.8515US8)		Lee et al.	Filed 08/29/2002	
	AJ✓	5,244,534✓		Yu et al.	09/14/1993	
	AK✓	5,300,155		Sandhu et al.	04/05/1994	
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	AO✓	5,676,587		Landers et al.	10/14/1997	
	AP✓	5,681,423		Sandhu et al.	10/28/1997	
↓	AQ✓	5,780,358		Zhou et al.	07/14/1998	

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		NUMBER	Kind Code (if known)			
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		NUMBER	Kind Code (if known)			
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		Office	NUMBER	Kind Code (if known)				
DVN	BX/	WO	00/26443		Talieh	05/11/2000		
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	BZ/	WO	00/32356		Talieh	06/08/2000		
	CA/	WO	00/59008		Talieh	10/05/2000		
↓	CB/	WO	00/59682		Talieh	10/12/2000		

### OTHER PRIOR ART-NON PATENT LITERATURE DOCUMENTS

Examiner Initials*	Cite No.	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume issue number(s), publisher, city and/or country where published.						T
DVN	CC/	FRANKENTHAL, R.P. and EATON, D.H., "Electroetching of Platinum in the Titanium-Platinum-Gold Metallization on Silicon Integrated Circuits", <i>Journal of The Electrochemical Society</i> , Vol. 123, No. 5, pp. 703-706, May 1976.						
	CD/	BERNHARDT, A.F., CONTOLINI, R.J., MAYER, S.T., "Electrochemical Planarization for Multi-Level Metallization of Microcircuitry," <i>CircuiTree Journal</i> , Vol. 8, No. 10, pp. 38, 40, 42, 44, 46, and 48, Oct. 1995.						
	CE/	HUANG, C.S. et al., "A Novel UV Baking Process to Improve DUV Photoresist Hardness", pp. 135-138.						
↓	CF/	ATMI Table of Contents, presented at the Semicon West '99 Low Dielectric Materials Technology Conference, July 12, 1999, pp. 13-25.						

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DVN	CG✓	Micro Photonics, Inc., CSM Application Bulletin, "Low-load Micro Scratch Tester (MST) for characterisation of thin polymer films", <a href="http://www.microphotonics.com/mstABpoly.html">http://www.microphotonics.com/mstABpoly.html</a> , 7/25/2002, 3 pages.		
	CH✓	Micro Photonics, Inc., "CSM Nano Hardness Tester", <a href="http://www.microphotonics.com/nht.html">http://www.microphotonics.com/nht.html</a> , 7/29/2002, 6 pages.		
	CI✓	PhysicsWorld – Table of Contents, PhysicsWeb, "Hard Materials", <a href="http://physicsweb.org/box/world/11/1/11/world-11-1-11-1">http://physicsweb.org/box/world/11/1/11/world-11-1-11-1</a> , 7/29/2002, 1 page.		

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